3M Z-Axis Adhesive Film (ZAF) 7303

Technical Data	April, 1999
	(Supersedes September, 1998)
Product Description	3M TM Z-Axis Adhesive Film (ZAF) 7303 is an electrically conductive thermoset adhesive film used to interconnect flexible circuits to printed circuit boards or other flexible circuits. Conductive particles loaded into the adhesive allow interconnection through the adhesive thickness (the Z-Axis) but they are spaced far enough apart for film 7303 to be electrically insulating in the plane of the adhesive.
Construction	Film 7303 is comprised of a 62.5 micron (2.5 mil) thick, thermosetting Acrylate/Epoxy adhesive loaded with silver coated glass beads. Film 7303 is coated on a poly-coated Kraft paper with silicone release. Film 7303 is a light tan color and has a slight amount of tack. The standard roll is 5 mm (0.2 in.) wide by 20 meters (18 yds.). Custom widths are available.

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Typical Properties

Note: The values in the table below are to be considered representative or typical and should not be used for specification purposes. Electronic circuit materials, surface preparations and assembly conditions vary widely; users are responsible for thoroughly evaluating the product under the conditions of intended use to determine the performance characteristics to be expected in their application.

Value	Units
Acrylate / Epoxy Blend	
Poly-coated Kraft with Silicone Release	
62.5 (2.5)	micron (mil)
100 (4)	micron (mil)
Silver-coated glass spheres	
35 (1.4)	micron (mil)
< 0.2	Ohms
0.25 (10)	mm (mil)
0.8 (1200)	mm² (mil²)
-40 to 80 (-40 to 177)	°C (°F)
5 or better	Ohms
14.1-17.6 (200-250)	Kg/cm ² (lbs/in ²)
533 (3)	g/cm ² (lbs/in ²)
135 (275)	°C (°F)
17.6 (250) 25	Kg/cm ² (lbs/in ²) seconds
	Value Acrylate / Epoxy Blend Poly-coated Kraft with Silicone Release 62.5 (2.5) 100 (4) Silver-coated glass spheres 35 (1.4) < 0.2 0.25 (10) 0.8 (1200) -40 to 80 (-40 to 177) 5 or better 14.1-17.6 (200-250) 135 (275) 17.6 (250) 25

⁽¹⁾For a given application, values may differ depending on particular flex circuit and PCB materials used.

⁽²⁾Measured for gold-coated copper/polyimide flex circuits bonded to solder-coated copper/FR-4 PCB's.

⁽³⁾Measured for silver-ink/polyester flex circuits bonded to gold- or solder-coated copper/FR-4 PCB (no solder mask in bond area).

- ⁽⁴⁾Long-term outdoor use may require additional reinforcement.
- ⁽⁵⁾Maximum measured resistance change in parts aged for two weeks at 77°C (170°F)/90% RH or after thermal cycling between -20°C and 70°C (-4°F and 158°F).

Available Sizes

Rolls: 5 mm (0.2 in.) wide x 20 meters (18 yds.) long. Custom widths greater than 5 mm up to 355 mm (14 inches) wide are available upon request. Rolls are provided upon 3 inch (76.2 mm) diameter plastic cores.

Sheets: Custom sizes are available up to 355 mm (14 inch) wide.

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Application Techniques	Bonding: Film 7303 requires a two part procedure: room temperature tacking of film 7303 to the flexible circuit (or to the PWB) and removal of the paper release liner, followed by bonding the flex to the second substrate using a thermocompression bonder. Detailed bonding instructions are available in the "Notes on 3M Z-Axis Film 7303 Bonding Sequence" Technical Service Bulletin, and these instructions must be followed to obtain good electrical and mechanical bonding.		
	Repair: Bonds made with 3M TM Z-Axis Adhesive Film 7303 are repairable without causing damage to a standard metal/FR-4 printed circuit board. Printed-ink/ polyester flex circuits may suffer damage to the ink (depending on the ink) such that a fresh bond area on the flex may need to be used (or a new flex). The following rework procedure is recommended: 1.) Peel the flex circuits from the PCB. Heating the substrates (70-100°C) [158-212°F] can reduce the force needed to peel them apart; 2.) Scrub the old adhesive away using a solvent such as methyl ethyl ketone or acetone (Note: Carefully read and follow the manufacturer's precautions and directions for the use of solvents); 3.) Apply a fresh length of film and repeat the bonding process.		
	Shelf Life: For long-term storage, product should be maintained at a temperature no higher than 25°C (77°F); temperatures during shipping should not exceed 40°C (104°F). Storage at 23°C (73°F) and 50% RH will afford a shelf life of at least 9 months after receipt of the product. Keeping the product refrigerated or frozen may extend the shelf life further.		
General Information	Film 7303 mechanical and electrical performance meets or exceed the performance of silver-ink polyester flexible circuits in environmental testing. Film 7303 has shown good electrical stability in testing such as temperature cycling between -20°C to 70°C (-4°F to 158°F) or high humidity storage at 77°C (170°F)/90% RH. The data contained in the Typical Properties Table was obtained on a specific flex to PCB interconnection, and the results in a customer application may differ. For specific performance information please contact your 3M Technical Service representative.		
Application Ideas	3M Z-Axis Film 7303 can connect and mechanically bond flexible printed circuits – especially printed silver-ink/polyester circuits to printed circuit boards or other flexible circuits. The minimum conductor spacing is 0.25 mm (10 mil) and the minimum pad overlap is 0.8 mm (1200 mil). Film 7303 is ideal for a wide variety of electronic interconnection applications. It is easy to use and suitable for systems requiring low electrical interconnect resistance even after weeks of exposure to difficult environmental conditions. The adhesive is tacky allowing for room temperature application to the flex circuit as well as alignment and temporary attachment of the flex to the PCB prior to hot bar bonding. For specific application recommendations please contact your 3M Technical Service representative.		

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For Additional Information	To request additional product information or to arrange for sales assistance, call toll free 1-800-362-3550. Address correspondence to: 3M Bonding Systems Division, 3M Center, Building 220-7E-01, St. Paul, MN 55144-1000. Our fax number is 651-733-9175. In Canada, phone: 1-800-364-3577. In Puerto Rico, phone: 1-809-750-3000. In Mexico, phone: 5-728-2180.
Certification/ Recognition	Meets IPC 3408 General Requirements for Antisotropic Conductive Adhesive Films.
Important Notice	3M MAKES NO WARRANTIES, EXPRESS OR IMPLIED, INCLUDING, BUT NOT LIMITED TO, ANY IMPLIED WARRANTY OF MERCHANTABILITY OR FITNESS FOR A PARTICULAR PURPOSE. User is responsible for determining whether the 3M product is fit for a particular purpose and suitable for user's method of application. Please remember that many factors can affect the use and performance of a 3M product in a particular application. The materials to be bonded with the product, the surface preparation of those materials, the product selected for use, the conditions in which the product is used, and the time and environmental conditions in which the product is expected to perform are among the many factors that can affect the use and performance of a 3M product. Given the variety of factors that can affect the use and performance of a 3M product, some of which are uniquely within the user's knowledge and control, it is essential that the user evaluate the 3M product to determine whether it is fit for a particular purpose and suitable for the user's method of application.
Limitation of Remedies and Liability	If the 3M product is proved to be defective, THE EXCLUSIVE REMEDY, AT 3M'S OPTION, SHALL BE TO REFUND THE PURCHASE PRICE OF OR TO REPAIR OR REPLACE THE DEFECTIVE 3M PRODUCT. 3M shall not otherwise be liable for loss or damages, whether direct, indirect, special, incidental, or consequential, regardless of the legal theory asserted, including negligence, warranty, or strict liability.



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Printed in U.S.A. ©3M 1999 70-0707-3832-6